June 2009

FAIRCHILD SEMICONDUCTOR®

FDB120N10 N-Channel PowerTrench[®] MOSFET 100V, 74A, 12mΩ

Features

- $R_{DS(on)} = 9.7m\Omega$ (Typ.)@ $V_{GS} = 10V$, $I_D = 74A$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

Description

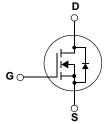
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

• DC to DC Converters / Synchronous Rectification







www. DaMOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DSS}	Drain to Source Voltage	ain to Source Voltage			V
V _{GSS}	Gate to Source Voltage	to Source Voltage			V
I _D	Drain Current	- Continuous (T _C = 25°C)		74	
	Drain Current	- Continuous ($T_C = 100^{\circ}C$)		52	— A
I _{DM}	Drain Current	- Pulsed (Note 1)		296	A
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	198	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	5.8	V/ns
P _D	Dower Dissinction	(T _C = 25°C)		170	W
	Power Dissipation	- Derate above 25°C		1.14	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

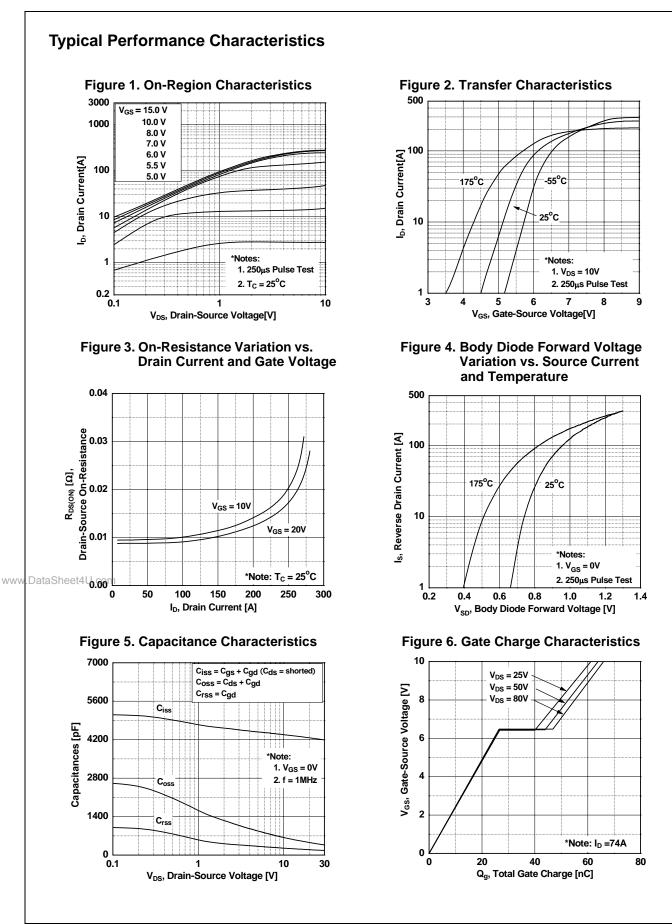
Thermal Characteristics

Symbol	Parameter	Ratings	Units
R_{\thetaJC}	Thermal Resistance, Junction to Case	0.88	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	0/00

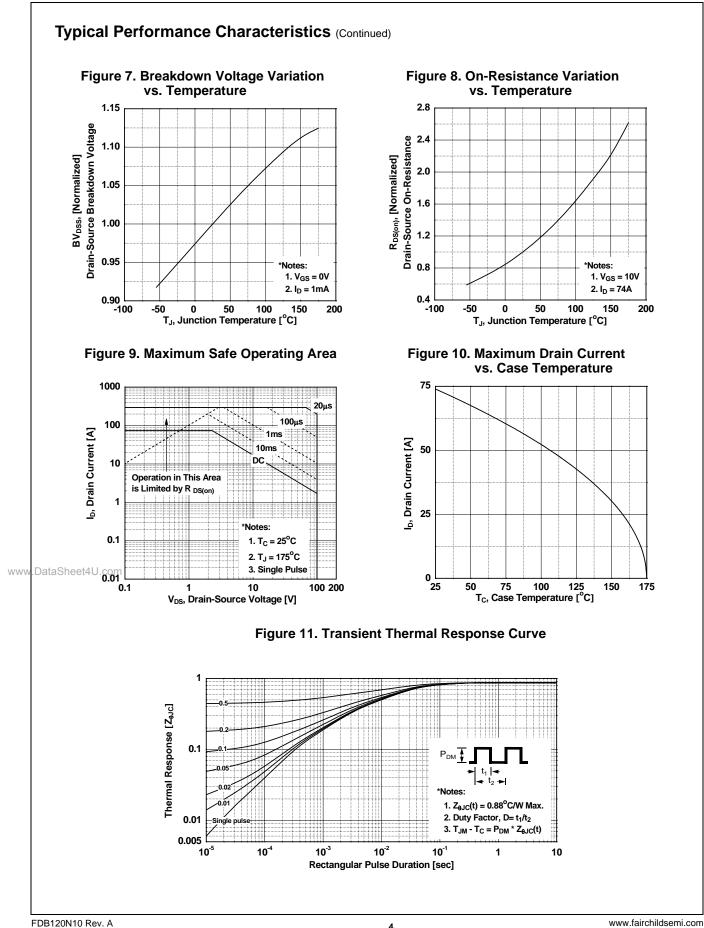
-		Package)	Reel Size	Таре	e Width		Quantit	у	
		D2-PAK	AK 330mm 2		24	24mm		800		
Electrica	I Char	acteristics T_{c} =	25°C unless ot	therwise note	d					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units	
Off Charac	teristic	s								
BV _{DSS}	Drain to Source Breakdown Voltage			I _D = 250μA, V _{GS} = 0V, T _C = 25°C			100	_	-	V
ABV _{DSS}						100				
ΔT_{J}	Breakdown Voltage Temperature Coefficient			$I_D = 250\mu A$, Referenced to $25^{\circ}C$		-	0.1	-	V/ºC	
	7 0			V _{DS} = 100V,	$V_{GS} = 0V$		-	-	1	
DSS	Zero Ga	Zero Gate Voltage Drain Current		$V_{DS} = 100V, V_{GS} = 0V, T_{C} = 150^{\circ}C$			-	-	500	μA
GSS	Gate to	Body Leakage Curren		$V_{GS} = \pm 20V,$			-	-	±100	nA
On Charac	toristic	e				1			1	1
V _{GS(th)}	Gate Threshold Voltage			V _{GS} = V _{DS} , I _I	5 = 250µA		2.5	-	4.5	V
R _{DS(on)}		rain to Source On Res		$V_{GS} = 10V, I_D = 74A$				9.7	12	mΩ
JFS	Forward Transconductance			$V_{\rm DS} = 10V, I_{\rm D} = 74A$ (Note 4)			-	105	-	S
					,	, ,				_
C _{iss}	Characteristics Input Capacitance						-	4215	5605	pF
	· ·	Capacitance	v	$V_{DS} = 25V, V_{GS} = 0V$	_	-	4213	540	pF	
C _{oss}	-	e Transfer Capacitance		f = 1MHz		-	-	170	255	pF
C _{rss}		ate Charge at 10V	,				-	66	86	nC
Q _{g(tot)}		Source Gate Charge		V _{DS} = 80V I _D = 74A	-	26	00	nC		
Q _{gs}				$V_{GS} = 10V$		-	-	-	-	
Q _{gd}	Gale IO	Drain "Miller" Charge				(Note 4, 5)	-	20	-	nC
Switching	1		T							
t _{d(on)}		On Delay Time			744	_	-	27	64	ns
tr		n Rise Time		$V_{DD} = 50V, I_D = 74A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$		-	105	220	ns	
t _{d(off)}		f Delay Time				_	-	39	88	ns
t _f	Turn-Of	f Fall Time				(Note 4, 5)	-	15	40	ns
Drain-Soui	ce Diod	de Characteristic	S							
S	Maximum Continuous Drain to Source Diode Forward Current					-	-	74	Α	
SM	Maximu	Maximum Pulsed Drain to Source Diode Fo						-	296	Α
V _{SD}	Drain to Source Diode Forward Voltage		d Voltage	$V_{GS} = 0V, I_{SD} = 74A$		-	-	1.3	V	
t _{rr}		Reverse Recovery Time		$V_{GS} = 0V, I_{SD} = 74A$		-	44	-	ns	
Q _{rr}	Reverse	e Recovery Charge	C	dl _F /dt = 100A	/μs	(Note 4)	-	67	-	nC
2. L = 0.11mH, I _{AS} 3. I _{SD} ≤ 74A, di/dt 4. Pulse Test: Puls	= 60A, V _{DD} = ≤ 200A/μs, V se width ≤ 300	h limited by maximum junction = 50V, $R_G = 25\Omega$, Starting $T_J =$ $_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}$ $D\mu$ s, Duty Cycle $\le 2\%$ Iperating Temperature Typical	= 25°C C							

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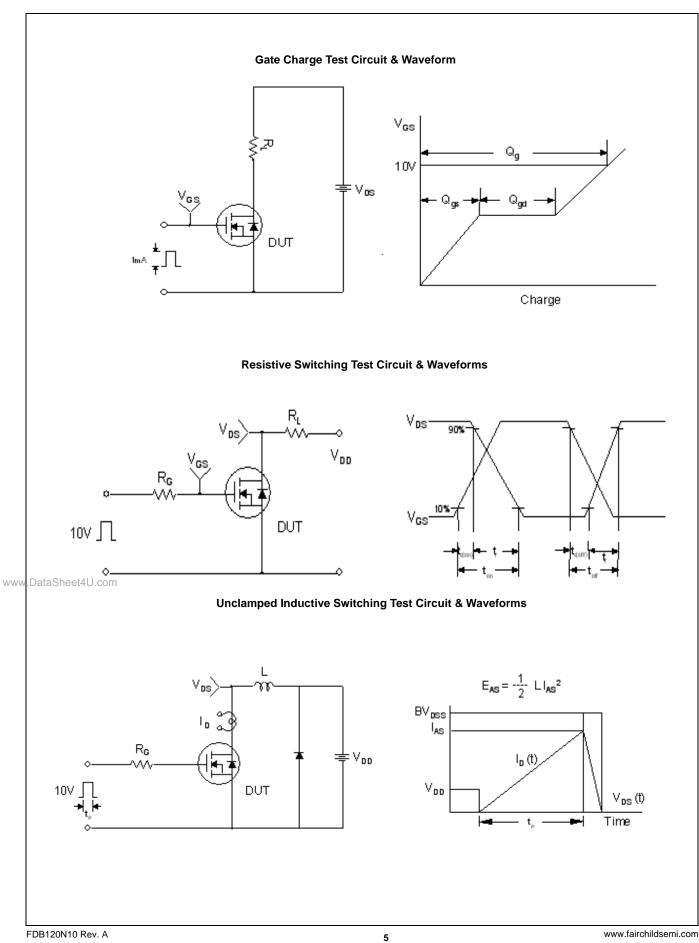
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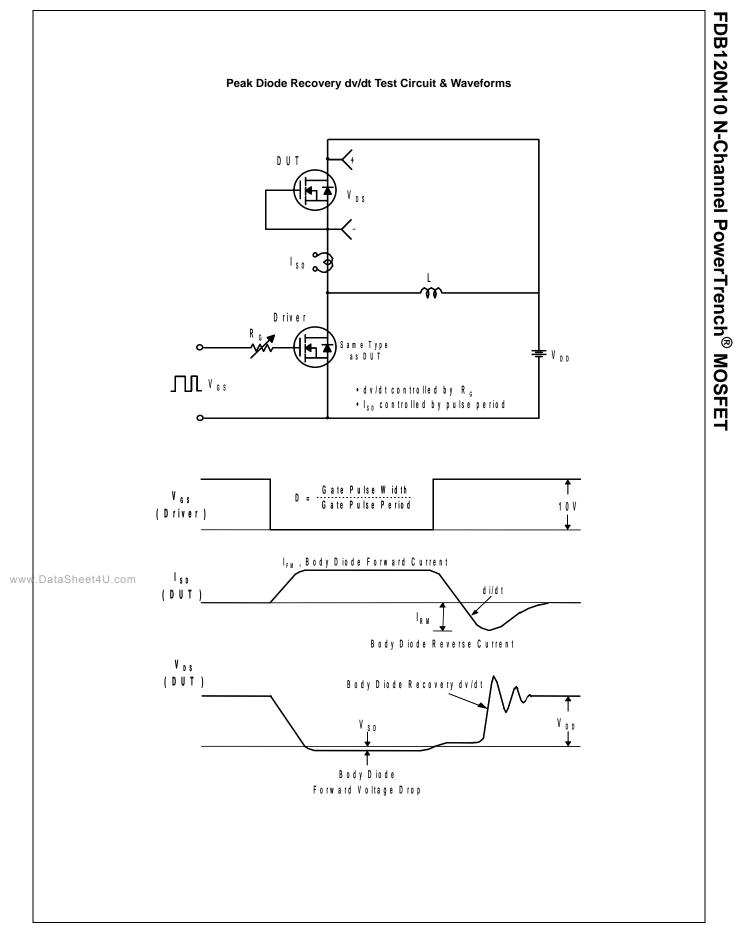


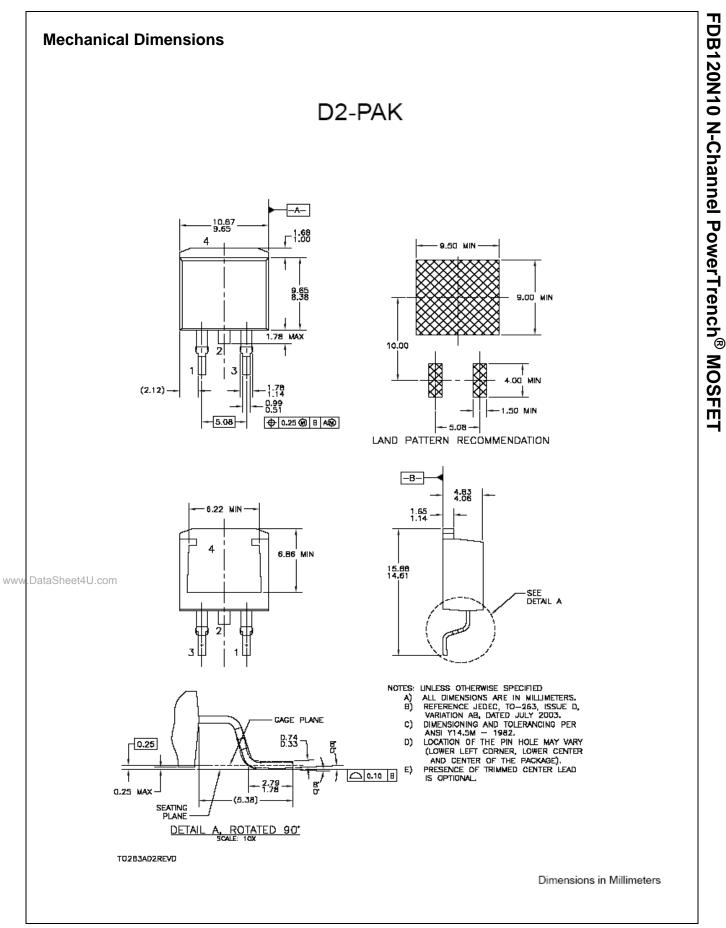
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FDB120N10 Rev. A



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